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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	I <sup>2</sup> C, IRSCI, SCI, SPI
Peripherals	LED, LVD, POR, PWM
Number of I/O	32
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-QFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mc908ap64cfber">https://www.e-xfl.com/product-detail/nxp-semiconductors/mc908ap64cfber</a>

**Table 2-1. Vector Addresses (Continued)**

Priority	INT Flag	Address	Vector
<div style="text-align: center;">   Highest </div>	IF8	\$FFEC	TIM2 Channel 1 Vector (High)
		\$FFED	TIM2 Channel 1 Vector (Low)
	IF7	\$FFEE	TIM2 Channel 0 Vector (High)
		\$FFEF	TIM2 Channel 0 Vector (Low)
	IF6	\$FFF0	TIM1 Overflow Vector (High)
		\$FFF1	TIM1 Overflow Vector (Low)
	IF5	\$FFF2	TIM1 Channel 1 Vector (High)
		\$FFF3	TIM1 Channel 1 Vector (Low)
	IF4	\$FFF4	TIM1 Channel 0 Vector (High)
		\$FFF5	TIM1 Channel 0 Vector (Low)
	IF3	\$FFF6	PLL Vector (High)
		\$FFF7	PLL Vector (Low)
	IF2	\$FFF8	IRQ2 Vector (High)
		\$FFF9	IRQ2 Vector (Low)
	IF1	\$FFFA	IRQ1 Vector (High)
		\$FFFB	IRQ1 Vector (Low)
	—	\$FFFC	SWI Vector (High)
		\$FFFD	SWI Vector (Low)
	—	\$FFFE	Reset Vector (High)
		\$FFFF	Reset Vector (Low)

## 2.4 Random-Access Memory (RAM)

The following table shows the RAM size and address range:

Device	RAM Size (Bytes)	Memory Address Range
MC68HC908AP64	2,048	\$0060–\$085F
MC68HC908AP32		
MC68HC908AP16	1,024	\$0060–\$045F
MC68HC908AP8		

The location of the stack RAM is programmable. The 16-bit stack pointer allows the stack to be anywhere in the 64k-byte memory space.

### 4.3 CPU Registers

Figure 4-1 shows the five CPU registers. CPU registers are not part of the memory map.

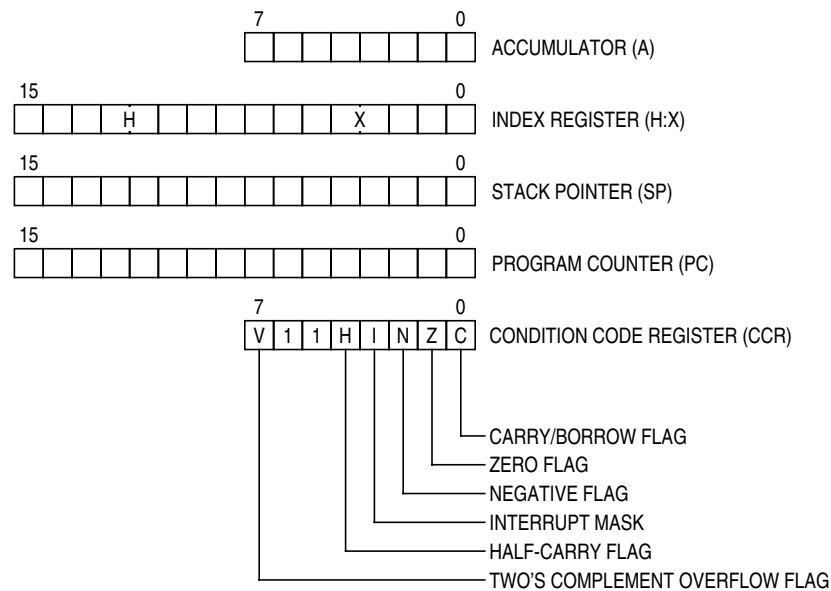


Figure 4-1. CPU Registers

#### 4.3.1 Accumulator

The accumulator is a general-purpose 8-bit register. The CPU uses the accumulator to hold operands and the results of arithmetic/logic operations.

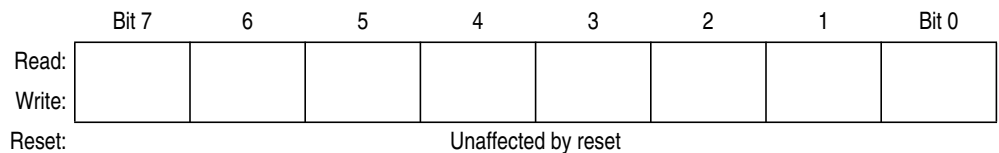


Figure 4-2. Accumulator (A)

#### 4.3.2 Index Register

The 16-bit index register allows indexed addressing of a 64-Kbyte memory space. H is the upper byte of the index register, and X is the lower byte. H:X is the concatenated 16-bit index register.

In the indexed addressing modes, the CPU uses the contents of the index register to determine the conditional address of the operand.

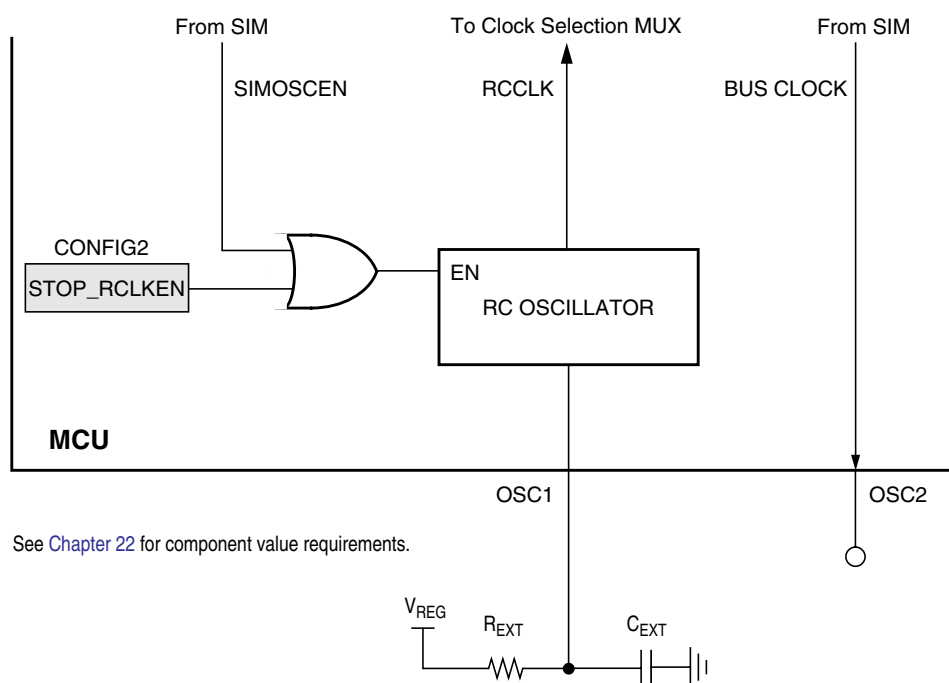
The index register can serve also as a temporary data storage location.

## 5.4 RC Oscillator

The RC oscillator circuit is designed for use with an external resistor and a capacitor.

In its typical configuration, the RC oscillator requires two external components, one R and one C. Component values should have a tolerance of 1% or less, to obtain a clock source with less than 10% tolerance. The oscillator configuration uses two components:

- $C_{EXT}$
- $R_{EXT}$



**Figure 5-5. RC Oscillator**

## 5.5 X-tal Oscillator

The crystal (x-tal) oscillator circuit is designed for use with an external 32.768kHz crystal to provide an accurate clock source.

In its typical configuration, the x-tal oscillator is connected in a Pierce oscillator configuration, as shown in Figure 5-6. This figure shows only the logical representation of the internal components and may not represent actual circuitry. The oscillator configuration uses five components:

- Crystal,  $X_1$  (32.768kHz)
- Fixed capacitor,  $C_1$
- Tuning capacitor,  $C_2$  (can also be a fixed capacitor)
- Feedback resistor,  $R_B$
- Series resistor,  $R_S$  (optional)

**NOTE**

*PLLON and BCS have built-in protection that prevents the base clock selector circuit from selecting the VCO clock as the source of the base clock if the PLL is off. Therefore, PLLON cannot be cleared when BCS is set, and BCS cannot be set when PLLON is clear. If the PLL is off (PLLON = 0), selecting CGMPCLK requires two writes to the PLL control register. (See 6.3.8 Base Clock Selector Circuit.)*

**PRE1 and PRE0 — Prescaler Program Bits**

These read/write bits control a prescaler that selects the prescaler power-of-two multiplier, P. (See 6.3.3 PLL Circuits and 6.3.6 Programming the PLL.) PRE1 and PRE0 cannot be written when the PLLON bit is set. Reset clears these bits.

These prescaler bits affects the relationship between the VCO clock and the final system bus clock.

**Table 6-2. PRE1 and PRE0 Programming**

PRE1 and PRE0	P	Prescaler Multiplier
00	0	1
01	1	2
10	2	4
11	3	8

**VPR1 and VPR0 — VCO Power-of-Two Range Select Bits**

These read/write bits control the VCO's hardware power-of-two range multiplier E that, in conjunction with L (See 6.3.3 PLL Circuits, 6.3.6 Programming the PLL, and 6.5.4 PLL VCO Range Select Register.) controls the hardware center-of-range frequency,  $f_{VRS}$ . VPR1:VPR0 cannot be written when the PLLON bit is set. Reset clears these bits.

**Table 6-3. VPR1 and VPR0 Programming**

VPR1 and VPR0	E	VCO Power-of-Two Range Multiplier
00	0	1
01	1	2
10	2	4

NOTE: Do not program E to a value of 3.

**Table 8-4. READ (Read Memory) Command**

<b>Description</b>	Read byte from memory
<b>Operand</b>	2-byte address in high-byte:low-byte order
<b>Data Returned</b>	Returns contents of specified address
<b>Opcode</b>	\$4A
<p style="text-align: center;"><b>Command Sequence</b></p>	

**Table 8-5. WRITE (Write Memory) Command**

<b>Description</b>	Write byte to memory
<b>Operand</b>	2-byte address in high-byte:low-byte order; low byte followed by data byte
<b>Data Returned</b>	None
<b>Opcode</b>	\$49
<p style="text-align: center;"><b>Command Sequence</b></p>	

## Monitor ROM (MON)

The start location of the FLASH to be programmed is specified by the address ADDRH:ADDRL and the number of bytes from this location is specified by DATASIZE. The maximum number of bytes that can be programmed in one routine call is 255 bytes (max. DATASIZE is 255).

ADDRH:ADDRL do not need to be at a page boundary, the routine handles any boundary misalignment during programming. A check to see that all bytes in the specified range are erased is not performed by this routine prior programming. Nor does this routine do a verification after programming, so there is no return confirmation that programming was successful. User must assure that the range specified is first erased.

The coding example below is to program 64 bytes of data starting at FLASH location \$EE00, with a bus speed of 4.9152 MHz. The coding assumes the data block is already loaded in RAM, with the address pointer, FILE\_PTR, pointing to the first byte of the data block.

```

                ORG      RAM
:
FILE_PTR:
BUS_SPD        DS.B    1      ; Indicates 4x bus frequency
DATASIZE       DS.B    1      ; Data size to be programmed
START_ADDR     DS.W    1      ; FLASH start address
DATAARRAY      DS.B    64     ; Reserved data array

PRGRNGE        EQU     $FC34
FLASH_START    EQU     $EE00

                ORG      FLASH
INITIALISATION:
    MOV        #20,     BUS_SPD
    MOV        #64,     DATASIZE
    LDHX       #FLASH_START
    STHX       START_ADDR
    RTS

MAIN:
    BSR        INITIALISATION
:
:
    LDHX       #FILE_PTR
    JSR        PRGRNGE

```

# Chapter 9

## Timer Interface Module (TIM)

### 9.1 Introduction

This section describes the timer interface (TIM) module. The TIM is a two-channel timer that provides a timing reference with Input capture, output compare, and pulse-width-modulation functions. [Figure 9-1](#) is a block diagram of the TIM.

This particular MCU has two timer interface modules which are denoted as TIM1 and TIM2.

### 9.2 Features

Features of the TIM include:

- Two input capture/output compare channels:
  - Rising-edge, falling-edge, or any-edge input capture trigger
  - Set, clear, or toggle output compare action
- Buffered and unbuffered pulse-width-modulation (PWM) signal generation
- Programmable TIM clock input with 7-frequency internal bus clock prescaler selection
- Free-running or modulo up-count operation
- Toggle any channel pin on overflow
- TIM counter stop and reset bits

### 9.3 Pin Name Conventions

The text that follows describes both timers, TIM1 and TIM2. The TIM input/output (I/O) pin names are T[1,2]CH0 (timer channel 0) and T[1,2]CH1 (timer channel 1), where “1” is used to indicate TIM1 and “2” is used to indicate TIM2. The two TIMs share four I/O pins with four I/O port pins. The external clock input for TIM2 is shared with the an ADC channel pin. The full names of the TIM I/O pins are listed in [Table 9-1](#). The generic pin names appear in the text that follows.

**Table 9-1. Pin Name Conventions**

TIM Generic Pin Names:		T[1,2]CH0	T[1,2]CH1
Full TIM Pin Names:	TIM1	PTB4/T1CH0	PTB5/T1CH1
	TIM2	PTB6/T2CH0	PTB7/T2CH1

**NOTE**

*References to either timer 1 or timer 2 may be made in the following text by omitting the timer number. For example, TCH0 may refer generically to T1CH0 and T2CH0, and TCH1 may refer to T1CH1 and T2CH1.*



### TBR[2:0] — Timebase Rate Selection

These read/write bits are used to select the rate of timebase interrupts as shown in [Table 10-1](#).

#### NOTE

*Do not change TBR[2:0] bits while the timebase is enabled (TBON = 1).*

**Table 10-1. Timebase Rate Selection for OSCCLK = 32.768-kHz**

TBR2	TBR1	TBR0	Divider	Timebase Interrupt Rate	
				Hz	ms
0	0	0	262144	0.125	8000
0	0	1	131072	0.25	4000
0	1	0	65536	0.5	2000
0	1	1	32768	1	1000
1	0	0	64	512	~2
1	0	1	32	1024	~1
1	1	0	16	2048	~0.5
1	1	1	8	4096	~0.24

### TACK — Timebase ACKnowledge

The TACK bit is a write-only bit and always reads as 0. Writing a logic 1 to this bit clears TBIF, the timebase interrupt flag bit. Writing a logic 0 to this bit has no effect.

1 = Clear timebase interrupt flag

0 = No effect

### TBIE — Timebase Interrupt Enabled

This read/write bit enables the timebase interrupt when the TBIF bit becomes set. Reset clears the TBIE bit.

1 = Timebase interrupt enabled

0 = Timebase interrupt disabled

### TBON — Timebase Enabled

This read/write bit enables the timebase. Timebase may be turned off to reduce power consumption when its function is not necessary. The counter can be initialized by clearing and then setting this bit. Reset clears the TBON bit.

1 = Timebase enabled

0 = Timebase disabled and the counter initialized to 0's

## 10.5 Interrupts

The timebase module can interrupt the CPU on a regular basis with a rate defined by TBR[2:0]. When the timebase counter chain rolls over, the TBIF flag is set. If the TBIE bit is set, enabling the timebase interrupt, the counter chain overflow will generate a CPU interrupt request. The interrupt vector is defined in [Table 2-1 . Vector Addresses](#).

Interrupts must be acknowledged by writing a logic 1 to the TACK bit.

## 10.6 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power- consumption standby modes.

### 10.6.1 Wait Mode

The timebase module remains active after execution of the WAIT instruction. In wait mode, the timebase register is not accessible by the CPU.

If the timebase functions are not required during wait mode, reduce the power consumption by stopping the timebase before enabling the WAIT instruction.

### 10.6.2 Stop Mode

The timebase module may remain active after execution of the STOP instruction if the oscillator has been enabled to operate during stop mode through the stop mode oscillator enable bit (STOP\_ICLKDIS, STOP\_RCLKEN, or STOP\_XCLKEN) for the selected oscillator in the CONFIG2 register. The timebase module can be used in this mode to generate a periodic walk-up from stop mode.

If the oscillator has not been enabled to operate in stop mode, the timebase module will not be active during stop mode. In stop mode the timebase register is not accessible by the CPU.

If the timebase functions are not required during stop mode, reduce the power consumption by stopping the timebase before enabling the STOP instruction.

### 11.4.2.1 Character Length

The transmitter can accommodate either 8-bit or 9-bit data. The state of the M bit in SCI control register 1 (SCC1) determines character length. When transmitting 9-bit data, bit T8 in SCI control register 3 (SCC3) is the ninth bit (bit 8).

### 11.4.2.2 Character Transmission

During an SCI transmission, the transmit shift register shifts a character out to the TxD pin. The SCI data register (SCDR) is the write-only buffer between the internal data bus and the transmit shift register. To initiate an SCI transmission:

1. Enable the SCI by writing a logic 1 to the enable SCI bit (ENSCI) in SCI control register 1 (SCC1).
2. Enable the transmitter by writing a logic 1 to the transmitter enable bit (TE) in SCI control register 2 (SCC2).
3. Clear the SCI transmitter empty bit by first reading SCI status register 1 (SCS1) and then writing to the SCDR.
4. Repeat step 3 for each subsequent transmission.

At the start of a transmission, transmitter control logic automatically loads the transmit shift register with a preamble of logic 1s. After the preamble shifts out, control logic transfers the SCDR data into the transmit shift register. A logic 0 start bit automatically goes into the least significant bit position of the transmit shift register. A logic 1 stop bit goes into the most significant bit position.

The SCI transmitter empty bit, SCTE, in SCS1 becomes set when the SCDR transfers a byte to the transmit shift register. The SCTE bit indicates that the SCDR can accept new data from the internal data bus. If the SCI transmit interrupt enable bit, SCTIE, in SCC2 is also set, the SCTE bit generates a transmitter CPU interrupt request.

When the transmit shift register is not transmitting a character, the TxD pin goes to the idle condition, logic 1. If at any time software clears the ENSCI bit in SCI control register 1 (SCC1), the transmitter and receiver relinquish control of the port pin.

### 11.4.2.3 Break Characters

Writing a logic 1 to the send break bit, SBK, in SCC2 loads the transmit shift register with a break character. A break character contains all logic 0s and has no start, stop, or parity bit. Break character length depends on the M bit in SCC1. As long as SBK is at logic 1, transmitter logic continuously loads break characters into the transmit shift register. After software clears the SBK bit, the shift register finishes transmitting the last break character and then transmits at least one logic 1. The automatic logic 1 at the end of a break character guarantees the recognition of the start bit of the next character.

The SCI recognizes a break character when a start bit is followed by eight or nine logic 0 data bits and a logic 0 where the stop bit should be.

Receiving a break character has these effects on SCI registers:

- Sets the framing error bit (FE) in SCS1
- Sets the SCI receiver full bit (SCRF) in SCS1
- Clears the SCI data register (SCDR)
- Clears the R8 bit in SCC3
- Sets the break flag bit (BKF) in SCS2
- May set the overrun (OR), noise flag (NF), parity error (PE), or reception in progress flag (RPF) bits

## 11.5 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power- consumption standby modes.

### 11.5.1 Wait Mode

The SCI module remains active after the execution of a WAIT instruction. In wait mode, the SCI module registers are not accessible by the CPU. Any enabled CPU interrupt request from the SCI module can bring the MCU out of wait mode.

If SCI module functions are not required during wait mode, reduce power consumption by disabling the module before executing the WAIT instruction.

Refer to [7.6 Low-Power Modes](#) for information on exiting wait mode.

### 11.5.2 Stop Mode

The SCI module is inactive after the execution of a STOP instruction. The STOP instruction does not affect SCI register states. SCI module operation resumes after an external interrupt.

Because the internal clock is inactive during stop mode, entering stop mode during an SCI transmission or reception results in invalid data.

Refer to [7.6 Low-Power Modes](#) for information on exiting stop mode.

## 11.6 SCI During Break Module Interrupts

The system integration module (SIM) controls whether status bits in other modules can be cleared during the break state. The BCFE bit in the SIM break flag control register (SBFCR) enables software to clear status bits during the break state.

To allow software to clear status bits during a break interrupt, write a logic 1 to the BCFE bit. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), software can read and write I/O registers during the break state without affecting status bits. Some status bits have a 2-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is at logic 0. After the break, doing the second step clears the status bit.

## 11.7 I/O Signals

Port B shares two of its pins with the SCI module.

The two SCI I/O pins are:

- PTB2/TxD — Transmit data
- PTB3/RxD — Receive data

### 11.7.1 TxD (Transmit Data)

When the SCI is enabled (ENSCI=1), the PTB2/TxD pin becomes the serial data output, TxD, from the SCI transmitter regardless of the state of the DDRB2 bit in data direction register B (DDRB). The TxD pin is an open-drain output and requires a pullup resistor to be connected for proper SCI operation.

- Framing error (FE) — The FE bit in IRSCS1 is set when a logic 0 occurs where the receiver expects a stop bit. The framing error interrupt enable bit, FEIE, in IRSCC3 enables FE to generate SCI error CPU interrupt requests.
- Parity error (PE) — The PE bit in IRSCS1 is set when the SCI detects a parity error in incoming data. The parity error interrupt enable bit, PEIE, in IRSCC3 enables PE to generate SCI error CPU interrupt requests.

## 12.6 Low-Power Modes

The WAIT and STOP instructions put the MCU in low power- consumption standby modes.

### 12.6.1 Wait Mode

The SCI module remains active after the execution of a WAIT instruction. In wait mode, the SCI module registers are not accessible by the CPU. Any enabled CPU interrupt request from the SCI module can bring the MCU out of wait mode.

If SCI module functions are not required during wait mode, reduce power consumption by disabling the module before executing the WAIT instruction.

Refer to [7.6 Low-Power Modes](#) for information on exiting wait mode.

### 12.6.2 Stop Mode

The SCI module is inactive after the execution of a STOP instruction. The STOP instruction does not affect SCI register states. SCI module operation resumes after an external interrupt.

Because the internal clock is inactive during stop mode, entering stop mode during an SCI transmission or reception results in invalid data.

Refer to [7.6 Low-Power Modes](#) for information on exiting stop mode.

## 12.7 SCI During Break Module Interrupts

The system integration module (SIM) controls whether status bits in other modules can be cleared during interrupts generated by the break module. The BCFE bit in the SIM break flag control register (SBFCR) enables software to clear status bits during the break state.

To allow software to clear status bits during a break interrupt, write a logic 1 to the BCFE bit. If a status bit is cleared during the break state, it remains cleared when the MCU exits the break state.

To protect status bits during the break state, write a logic 0 to the BCFE bit. With BCFE at logic 0 (its default state), software can read and write I/O registers during the break state without affecting status bits. Some status bits have a two-step read/write clearing procedure. If software does the first step on such a bit before the break, the bit cannot change during the break state as long as BCFE is at logic 0. After the break, doing the second step clears the status bit.

## 12.8 I/O Signals

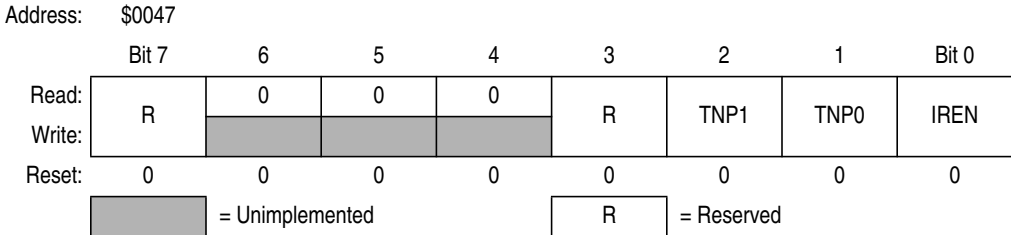
The two IRSCI I/O pins are:

- PTC6/SCTxD — Transmit data
- PTC7/SCRxD — Receive data

### 12.9.8 IRSCI Infrared Control Register

The infrared control register contains the control bits for the infrared sub-module.

- Enables the infrared sub-module
- Selects the infrared transmitter narrow pulse width



**Figure 12-20. IRSCI Infrared Control Register (IRSCIRCR)**

#### TNP1 and TNP0 — Transmitter Narrow Pulse Bits

These read/write bits select the infrared transmitter narrow pulse width as shown in [Table 12-10](#). Reset clears TNP1 and TNP0.

**Table 12-10. Infrared Narrow Pulse Selection**

TNP1 and TNP0	Prescaler Divisor (PD)
00	SCI transmits a 3/16 narrow pulse
01	SCI transmits a 1/16 narrow pulse
10	SCI transmits a 1/32 narrow pulse
11	

#### IREN — Infrared Enable Bit

This read/write bit enables the infrared sub-module for encoding and decoding the SCI data stream. When this bit is clear, the infrared sub-module is disabled. Reset clears the IREN bit.

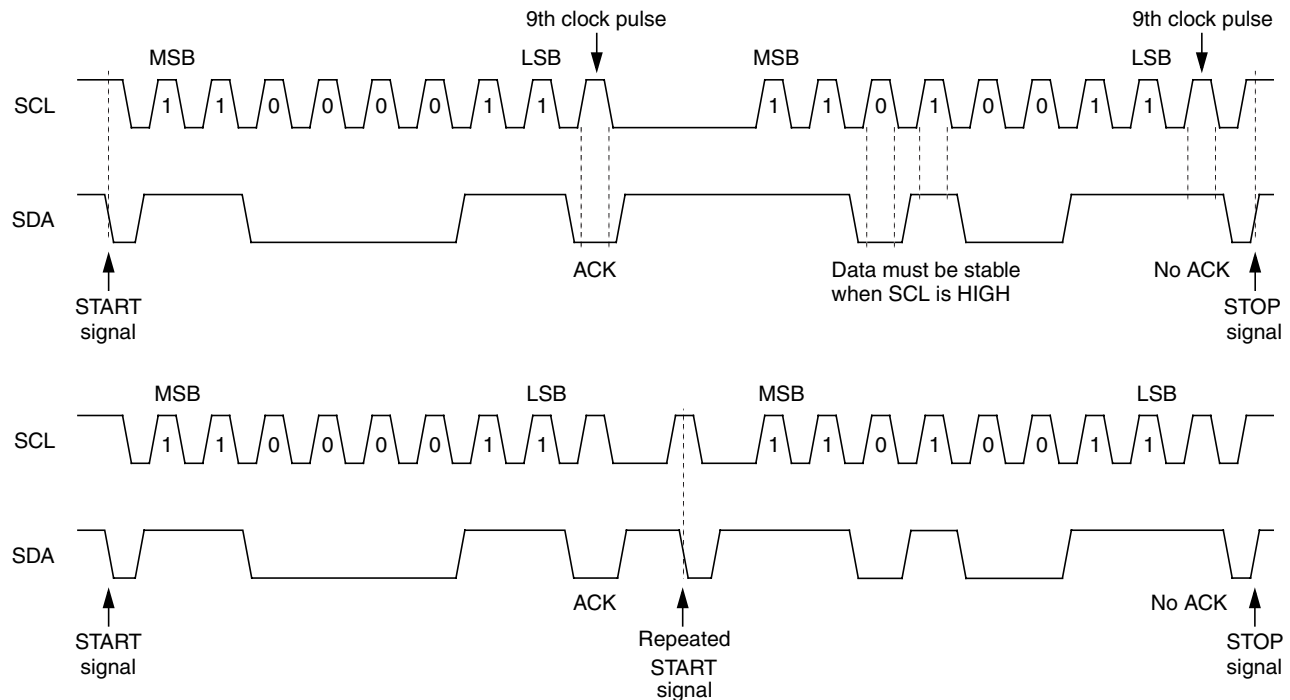
- 1 = infrared sub-module enabled
- 0 = infrared sub-module disabled

## 14.5 Multi-Master IIC Bus Protocol

Normally a standard communication is composed of four parts:

1. START signal,
2. slave address transmission,
3. data transfer, and
4. STOP signal.

These are described briefly in the following sections and illustrated in [Figure 14-2](#).



**Figure 14-2. Multi-Master IIC Bus Transmission Signal Diagram**

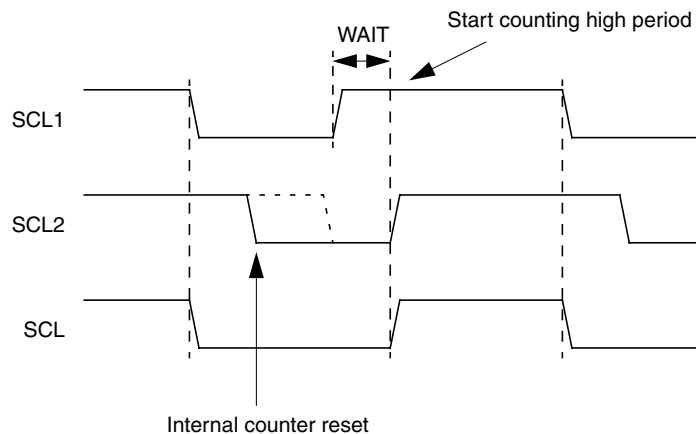
### 14.5.1 START Signal

When the bus is free, (i.e. no master device is engaging the bus — both SCL and SDA lines are at logic high) a master may initiate communication by sending a START signal. As shown in [Figure 14-2](#), a START signal is defined as a high to low transition of SDA while SCL is high. This signal denotes the beginning of a new data transfer (each data transfer may contain several bytes of data) and wakes up all slaves.

### 14.5.2 Slave Address Transmission

The first byte transferred immediately after the START signal is the slave address transmitted by the master. This is a 7-bit calling address followed by a R/W-bit. The R/W-bit dictates to the slave the desired direction of the data transfer. A logic 0 indicates that the master wishes to transmit data to the slave; a logic 1 indicates that the master wishes to receive data from the slave.

in this device clock may not change the state of the SCL line if another device clock is still in its low period. Therefore the synchronized clock SCL will be held low by the device which last releases SCL to logic high. Devices with shorter low periods enter a high wait state during this time. When all devices concerned have counted off their low period, the synchronized SCL line will be released and go high, and all devices will start counting their high periods. The first device to complete its high period will again pull the SCL line low. Figure 14-3 illustrates the clock synchronization waveforms.



**Figure 14-3. Clock Synchronization**

### 14.5.8 Handshaking

The clock synchronization mechanism can be used as a handshake in data transfer. A slave device may hold the SCL low after completion of one byte data transfer and will halt the bus clock, forcing the master clock into a wait state until the slave releases the SCL line.

### 14.5.9 Packet Error Code

The packet error code (PEC) for the MMIIC interface is in the form a cyclic redundancy code (CRC). The PEC is generated by hardware for every transmitted and received byte of data. The transmission of the generated PEC is controlled by user software.

The CRC data register, MMCRCDR, contains the generated PEC byte, with three other bits in the MMIIC control registers and status register monitoring and controlling the PEC byte.

## 14.6 MMIIC I/O Registers

These I/O registers control and monitor MMIIC operation:

- MMIIC address register (MMADR) — \$0048
- MMIIC control register 1 (MMCR1) — \$0049
- MMIIC control register 2 (MMCR2) — \$004A
- MMIIC status register (MMSR) — \$004B
- MMIIC data transmit register (MMDTR) — \$004C
- MMIIC data receive register (MMDRR) — \$004D
- MMIIC CRC data register (MMCRCDR) — \$004E
- MMIIC frequency divide register (MMFDR) — \$004F



When the MMIIC module is enabled,  $MMEN = 1$ , data written into this register depends on whether module is in master or slave mode.

In slave mode, the data in MMDTR will be transferred to the output circuit when:

- the module detects a matched calling address ( $MMATCH = 1$ ), with the calling master requesting data ( $MMSRW = 1$ ); or
- the previous data in the output circuit has been transmitted and the receiving master returns an acknowledge bit, indicated by a received acknowledge bit ( $MMRXAK = 0$ ).

If the calling master does not return an acknowledge bit ( $MMRXAK = 1$ ), the module will release the SDA line for master to generate a STOP or repeated START condition. The data in the MMDTR will not be transferred to the output circuit until the next calling from a master. The transmit buffer empty flag remains cleared ( $MMTXBE = 0$ ).

In master mode, the data in MMDTR will be transferred to the output circuit when:

- the module receives an acknowledge bit ( $MMRXAK = 0$ ), after setting master transmit mode ( $MMRW = 0$ ), and the calling address has been transmitted; or
- the previous data in the output circuit has been transmitted and the receiving slave returns an acknowledge bit, indicated by a received acknowledge bit ( $MMRXAK = 0$ ).


If the slave does not return an acknowledge bit ( $MMRXAK = 1$ ), the master will generate a STOP or repeated START condition. The data in the MMDTR will not be transferred to the output circuit. The transmit buffer empty flag remains cleared ( $MMTXBE = 0$ ).

The sequence of events for slave transmit and master transmit are illustrated in [Figure 14-12](#).

#### 14.6.6 MMIIC Data Receive Register (MMDRR)

Address: \$004D

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	MMRD7	MMRD6	MMRD5	MMRD4	MMRD3	MMRD2	MMRD1	MMRD0
Write:								
Reset:	0	0	0	0	0	0	0	0

 = Unimplemented

**Figure 14-9. MMIIC Data Receive Register (MMDRR)**

When the MMIIC module is enabled,  $MMEN = 1$ , data in this read-only register depends on whether module is in master or slave mode.

In slave mode, the data in MMDRR is:

- the calling address from the master when the address match flag is set ( $MMATCH = 1$ ); or
- the last data received when  $MMATCH = 0$ .

In master mode, the data in the MMDRR is:

- the last data received.

When the MMDRR is read by the CPU, the receive buffer full flag is cleared ( $MMRXBF = 0$ ), and the next received data is loaded to the MMDRR. Each time when new data is loaded to the MMDRR, the  $MMRXIF$  interrupt flag is set, indicating that new data is available in MMDRR.

The sequence of events for slave receive and master receive are illustrated in [Figure 14-12](#).

## 15.7 I/O Registers

These I/O registers control and monitor ADC operation:

- ADC status and control register (ADSCR) — \$0057
- ADC clock control register (ADICLK) — \$0058
- ADC data register high:low 0 (ADRH0:ADRL0) — \$0059:\$005A
- ADC data register low 1–3 (ADRL1–ADRL3) — \$005B–\$005D
- ADC auto-scan control register (ADASCAR) — \$005E

### 15.7.1 ADC Status and Control Register

Function of the ADC status and control register is described here.

Address:	\$0057							
Read:	COCO	AIEN	ADCO	ADCH4	ADCH3	ADCH2	ADCH1	ADCH0
Write:								
Reset:	0	0	0	1	1	1	1	1

**Figure 15-3. ADC Status and Control Register (ADSCR)**

#### COCO — Conversions Complete Bit

When the AIEN bit is a logic 0, the COCO is a read-only bit which is set each time a conversion is completed. This bit is cleared whenever the ADSCR is written, or whenever the ADC clock control register is written, or whenever the ADC data register low, ADRLx, is read.

If the AIEN bit is logic 1, the COCO bit always read as logic 0. ADC interrupt will be generated at the end of an ADC conversion. Reset clears the COCO bit.

1 = Conversion completed (AIEN = 0)

0 = Conversion not completed (AIEN = 0)/CPU interrupt (AIEN=1)

#### AIEN — ADC Interrupt Enable Bit

When this bit is set, an interrupt is generated at the end of an ADC conversion. The interrupt signal is cleared when the data register, ADR0, is read or the ADSCR is written. Reset clears the AIEN bit.

1 = ADC interrupt enabled

0 = ADC interrupt disabled

#### ADCO — ADC Continuous Conversion Bit

When set, the ADC will convert samples continuously and update the ADC data register at the end of each conversion. Only one conversion is allowed when this bit is cleared. Reset clears the ADCO bit.

1 = Continuous ADC conversion

0 = One ADC conversion

This bit should not be set when auto-scan mode is enabled; i.e. when ASCAN=1.

#### ADCH[4:0] — ADC Channel Select Bits

ADCH[4:0] form a 5-bit field which is used to select one of the ADC channels when not in auto-scan mode. The five channel select bits are detailed in [Table 15-1](#).

#### NOTE

*Care should be taken when using a port pin as both an analog and a digital input simultaneously to prevent switching noise from corrupting the analog signal. Recovery from the disabled state requires one conversion cycle to stabilize.*

### IMASK1 — IRQ1 Interrupt Mask Bit

Writing a logic 1 to this read/write bit disables IRQ1 interrupt requests. Reset clears IMASK1.

- 1 =  $\overline{\text{IRQ1}}$  interrupt requests disabled
- 0 =  $\overline{\text{IRQ1}}$  interrupt requests enabled

### MODE1 — IRQ1 Edge/Level Select Bit

This read/write bit controls the triggering sensitivity of the  $\overline{\text{IRQ1}}$  pin. Reset clears MODE1.

- 1 =  $\overline{\text{IRQ1}}$  interrupt requests on falling edges and low levels
- 0 =  $\overline{\text{IRQ1}}$  interrupt requests on falling edges only

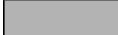
## 17.6.2 IRQ2 Status and Control Register

The IRQ2 status and control register (INTSCR2) controls and monitors operation of IRQ2. The INTSCR2 has the following functions:

- Enables/disables the internal pullup device on  $\overline{\text{IRQ2}}$  pin
- Shows the state of the IRQ2 flag
- Clears the IRQ2 latch
- Masks IRQ2 interrupt request
- Controls triggering sensitivity of the  $\overline{\text{IRQ2}}$  interrupt pin

Address: \$001C

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	0	PUC0ENB	0	0	IRQ2F	0	IMASK2	MODE2
Write:						ACK2		
Reset:	0	0	0	0	0	0	0	0

 = Unimplemented

**Figure 17-5. IRQ2 Status and Control Register (INTSCR2)**

### PUC0ENB — $\overline{\text{IRQ2}}$ Pin Pullup Enable Bit.

Setting this bit to logic 1 disables the pullup on PTC0/ $\overline{\text{IRQ2}}$  pin.

Reset clears this bit.

- 1 =  $\overline{\text{IRQ2}}$  pin internal pullup is disabled
- 0 =  $\overline{\text{IRQ2}}$  pin internal pullup is enabled

### IRQ2F — IRQ2 Flag Bit

This read-only status bit is high when the IRQ2 interrupt is pending.

- 1 =  $\overline{\text{IRQ2}}$  interrupt pending
- 0 =  $\overline{\text{IRQ2}}$  interrupt not pending

### ACK2 — IRQ2 Interrupt Request Acknowledge Bit

Writing a logic 1 to this write-only bit clears the IRQ2 latch. ACK2 always reads as logic 0. Reset clears ACK2.

### IMASK2 — IRQ2 Interrupt Mask Bit

Writing a logic 1 to this read/write bit disables IRQ2 interrupt requests. Reset clears IMASK2.

- 1 = IRQ2 interrupt requests disabled
- 0 = IRQ2 interrupt requests enabled

### MODE2 — IRQ2 Edge/Level Select Bit

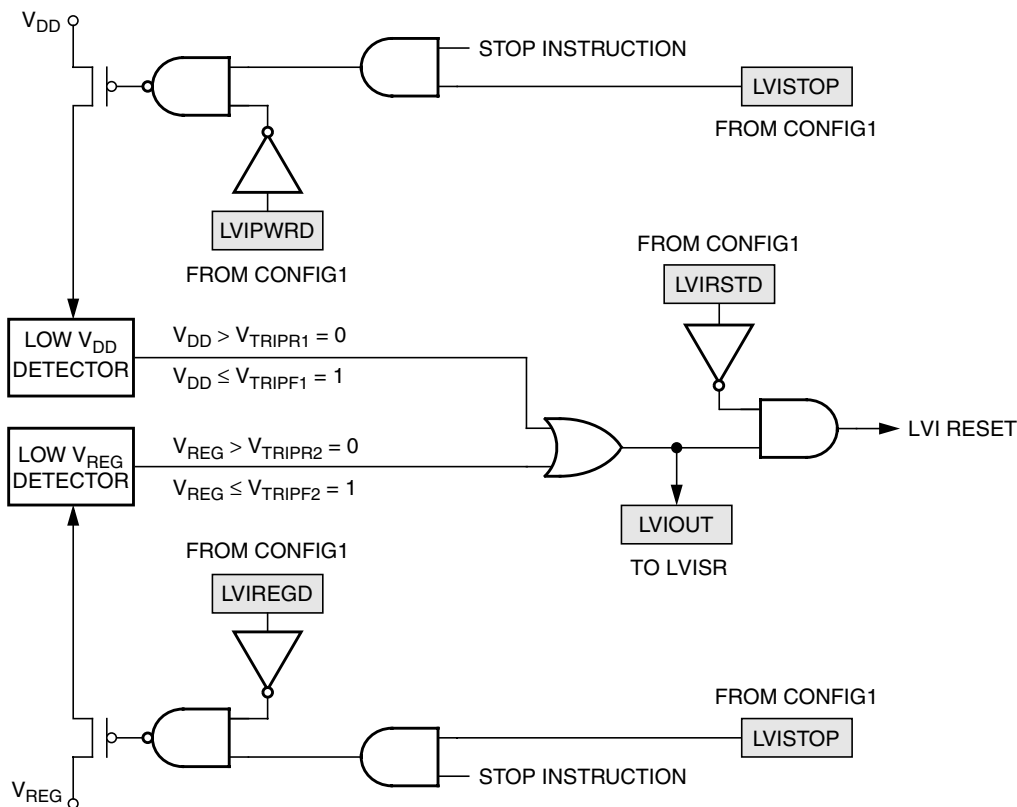
This read/write bit controls the triggering sensitivity of the  $\overline{\text{IRQ2}}$  pin. Reset clears MODE2.

- 1 = IRQ2 interrupt requests on falling edges and low levels
- 0 =  $\overline{\text{IRQ2}}$  interrupt requests on falling edges only

## Low-Voltage Inhibit (LVI)

an LVI reset occurs, the MCU remains in reset until  $V_{DD}$  rises above  $V_{TRIPR1}$  and  $V_{REG}$  rises above  $V_{TRIPR2}$ , which causes the MCU to exit reset. The output of the comparator controls the state of the LVIOUT flag in the LVI status register (LVISR).

An LVI reset also drives the  $\overline{RST}$  pin low to provide low-voltage protection to external peripheral devices.



**Figure 20-2. LVI Module Block Diagram**

### 20.3.1 Low $V_{DD}$ Detector

The low  $V_{DD}$  detector circuit monitors the  $V_{DD}$  voltage and forces a LVI reset when the  $V_{DD}$  voltage falls below the trip voltage,  $V_{TRIPF1}$ . The  $V_{DD}$  LVI circuit can be disabled by the setting the LVIPWRD bit in CONFIG1 register.

### 20.3.2 Low $V_{REG}$ Detector

The low  $V_{REG}$  detector circuit monitors the  $V_{REG}$  voltage and forces a LVI reset when the  $V_{REG}$  voltage falls below the trip voltage,  $V_{TRIPF2}$ . The  $V_{REG}$  LVI circuit can be disabled by the setting the LVIREGD bit in CONFIG1 register.

### 20.3.3 Polled LVI Operation

In applications that can operate at  $V_{DD}$  levels below the  $V_{TRIPF1}$  level, software can monitor  $V_{DD}$  by polling the LVIOUT bit. In the CONFIG1 register, the LVIPWRD bit must be at logic 0 to enable the LVI module, and the LVIRSTD bit must be at logic 1 to disable LVI resets.

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